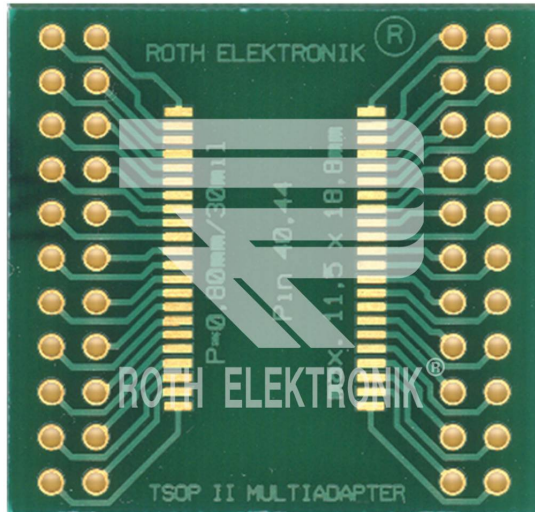


Adapter TSOP II



RE900-05

- FR4 EPOXY fibre-glass FR4 1.50 mm double-sided 35 µm CU (pth)
- solder and component side with chemical NI/AU surface and solder stop mask
- pitch spacings:
0.80 mm (30 mil)
- Pins:
40, 44
- hole dia Ø 1.00 mm
- Gerber data for manufacture of the soldering paste imprint will be provided free of charge on request
- size: 30.5 x 29.0 mm